

A Simulation of Moisture Diffusion Process in Furniture-Grade Medium Density Fiberboard

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Typical 5-ply Veneered Furniture Panel

Face (Wood Veneer - Mahogany)

Cross-band - (Wood - Yellow Poplar)

Cross-band - (Wood - Yellow Poplar)

Back - (Wood - Yellow Poplar)









Practical Warp Examples





Factors That Affect Panel Warping

Material Properties - MOE, LE
Geometric Configuration - TK, OR
Panel Construction
Internal Moisture Gradient



Moisture Distribution



2-ply Laminate





Moisture Diffusion Process in Wood and Wood Composite Panels

- * Extensive studies made for solid wood along the three principal directions
- Partial vapor pressure the most proper driving force for moisture transfer
- Limited study made for particleboard (e.g., Cai and Dek 1993, Wu and Suschland 1996)



Medium Density Fiberboard (MDF)

- Popular laminating material
- Fine internal structure
- No moisture diffusion study made



Objectives

- (a) To measure layer density, EMC and diffusion coefficients as a function of position across panel thickness in commercial MDF,
- (b) To develop a simulation model for the moisture diffusion process through MDF using partial vapor pressure as the driving force, and
- (c) To compare the model's prediction with measurements from the MDF panel.

Materials

25.4-mm Commercial MDF
Density/EMC/Diffusion Coefficient
20 "continuous" layers (1.27mm thick) across panel thickness)
Moisture Distribution

25.4-mm thick samples





Diffusion Coefficient

Diffusion Cell



RH Steps:

47%->20% 66%->47% 75%->66% 81%->75% 86%->81% 93%->86%

$$J = K \frac{dP}{dX}$$

J = diffusion rate (g/cm²/hr) K = diffusion coefficient (g/cm/mmHg/Hr) P = partial vapor pressure (mmHg) V = dimension secondinate (sm)

X = dimension coordinate (cm)



Moisture Diffusion Model

$$D C_{MC} \frac{\partial P}{\partial t} = \frac{\partial}{\partial X} (K \frac{\partial P}{\partial X})$$

D is density (g/cm³) C_{MC} is specific MC (%/mmHg) P is partial vapor pressure (mmHg) t is time (hour) X is distance across thickness (cm) K is diffusion coefficient (g/cm/mmHg/hour).



Solution Method- Diffusion Model

Diffusion Model

$$DC_{MC}\frac{\partial P}{\partial t} = \frac{\partial K}{\partial X} \frac{\partial P}{\partial X} + K \frac{\partial^2 P}{\partial X^2}$$

Finite Difference Approximation

$$\frac{\partial P}{\partial t} = \frac{P_{i,n+1} - P_{i,n}}{\Delta t}; \qquad \frac{\partial P}{\partial X} = \frac{P_{i+1,j} - P_{i-1,j}}{2\Delta X}; \qquad \frac{\partial^2 P}{\partial X^2} = \frac{P_{i-1,j} - 2P_{i,j} + P_{i+1,j}}{(\Delta X)^2}$$
$$\frac{\partial K}{\partial X} = \frac{\partial}{\partial X} (\alpha_0 + \alpha_1 P + \alpha_2 X + \alpha_3 P^2 + \alpha_4 X^2 + \alpha_5 P X) = \alpha_2 + 2\alpha_4 X + \alpha_5 P$$



RESULTS AND DISCUSSION

1.2 1 **Typical** Density 0.8 Density (g/cm3) Profile Across 0.6 Panel **Thickness** 0.4 for 25.4-mm 0.2 Thick MDF 0 5.08 0 2.54



Mean EMC As a function of Relative Humidity for 25.4-mm Thick MDF





14 12 Moisture Content (%) 10 8 6 4 2 0 2.5 10.2 12.7 15.2 17.8 20.3 22.9 25.4 0.0 5.1 7.6 Panel Thickness (mm) → RH=90 → RH=80 → RH=70 → RH=50

EMC Distribution Across Panel Thickness for 25.4-mm Thick MDF Sample weight change as a function of exposure time for diffusion coefficient measurements



Coefficient k as a function of RH level





Material Property Models

Density-Thickness Relation

 $D(g/cm^3) = 1.0258 - 1.3917X + 1.3205 X^2$

EMC-Position-Vapor Pressure Relation

EMC(%) = $(0.0084 + 0.0517P + 0.0289X + 0.0283X^{2})*100\%$

Diffusion Coefficient-Position-Vapor Pressure Relation

K (g/cm/mmHg/Hour)

 $= 0.000431 - 0.00107 P + 0.00192 X + 0.0005P^{2} - 0.00192 X^{2} + 0.000206 XP)$





+ 72 (M)

168 (M)

336 (M)

672 (M)

Ж

0 (M)

Predicted Moisture Distribution of MDF as a Function of Exposure Time



Conclusions

- (a) The densities of MDF varied across the board thickness with higher values near the board surface and lower values near the center.
- (b) The EMC of MDF at a given RH level was higher near the board center than the surface.
- (c) The diffusion coefficient of the MDF varied with both location over the board thickness and MC level.
- (d) The moisture diffusion process in MDF can be simulated theoretically by using Fick's second law and finite difference method.